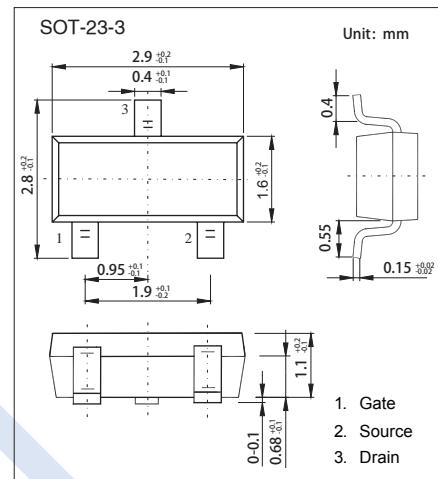
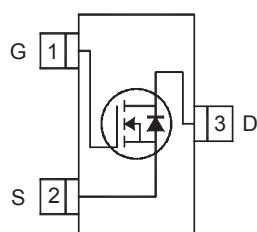


N-Channel MOSFET

2KK5060

■ Features

- $BV_{DSS} = 20\text{ V}$
- $I_D = 6\text{ A}$
- $R_{DS(\text{ON})} = 10\text{ m}\Omega(\text{Typ.}) @ V_{GS} = 4.5\text{ V}$
- $R_{DS(\text{ON})} = 15\text{ m}\Omega(\text{Typ.}) @ V_{GS} = 2.5\text{ V}$



■ Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V_{GS}	± 12	
Continuous Drain Current (Note 1)	I_D	6	A
		4.5	
Pulsed Drain Current (Note 2)	I_{DM}	24	
Power Dissipation	P_D	1.25	W
		0.75	
Thermal Resistance. Junction- to-Ambient (Note 3)	R_{JA}	100	$^{\circ}\text{C}/\text{W}$
Junction Temperature	T_J	150	
Storage Temperature Range	T_{stg}	-55 to 150	$^{\circ}\text{C}$

Notes:

1. Calculated continuous current based on maximum allowable junction temperature.
2. Pulse width limited by safe operating area.
3. When mounted on 1 inch square copper board, $t \leq 10\text{ sec}$. The value in any given application depends on the user's specific board design.

N-Channel MOSFET**2KK5060****■ Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise specified)**

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D = 250 \mu\text{A}, V_{GS} = 0\text{V}$	20			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA
		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125^\circ\text{C}$			30	
Gate to Source Leakage Current	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 10 \text{ V}$			± 100	nA
Gate to Source Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	0.5		1.1	V
Static Drain-Source On-Resistance *	$R_{DS(\text{ON})}$	$V_{GS} = 4.5 \text{ V}, I_D = 6 \text{ A}$		10	13	$\text{m}\Omega$
		$V_{GS} = 2.5 \text{ V}, I_D = 5 \text{ A}$		15	18	
Gate Resistance	R_G	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$		1.5		Ω
Input Capacitance	C_{iss}	$V_{GS} = 0 \text{ V}, V_{DS} = 10 \text{ V}, f = 1 \text{ MHz}$		590		pF
Output Capacitance	C_{oss}			125		
Reverse Transfer Capacitance	C_{rss}			90		
Total Gate Charge	Q_g	$V_{GS} = 4.5 \text{ V}, V_{DS} = 16 \text{ V}, I_D = 6 \text{ A}$		10		nC
Gate Source Charge	Q_{gs}			1.6		
Gate Drain Charge	Q_{gd}			3.4		
Turn-On Delay Time	$t_{d(on)}$	$V_{GEN} = 4.5 \text{ V}, V_{DD} = 10 \text{ V}, I_D = 6 \text{ A}, R_G = 6\Omega$		8		ns
Turn-On Rise Time	t_r			15		
Turn-Off Delay Time	$t_{d(off)}$			33		
Turn-Off Fall Time	t_f			13		
Diode Forward Voltage	V_{SD}	$V_{GS} = 0 \text{ V}, I_S = 1 \text{ A}$			1	V
Reverse Recovery Time	t_{rr}	$I_{SD} = 1 \text{ A}, dI_{SD}/dt = 100 \text{ A}/\mu\text{s}$		15		ns
Reverse Recovery Charge	Q_{rr}			8		nC

* : Pulse test; Pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.

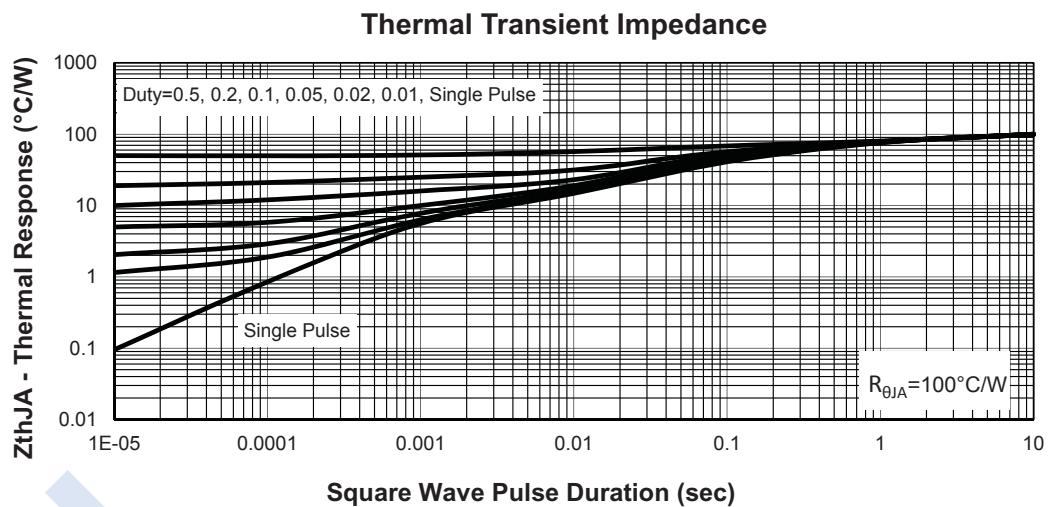
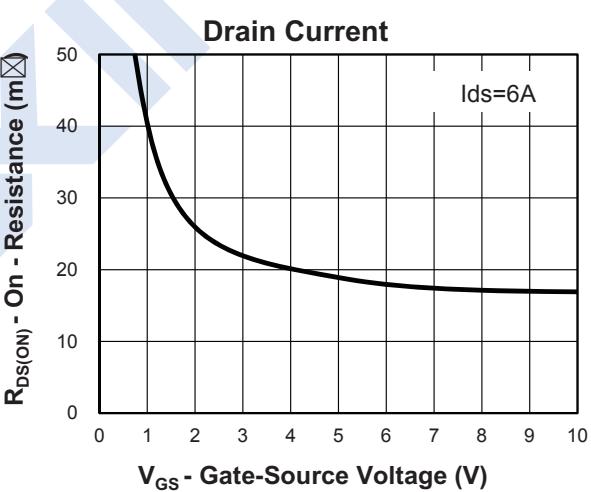
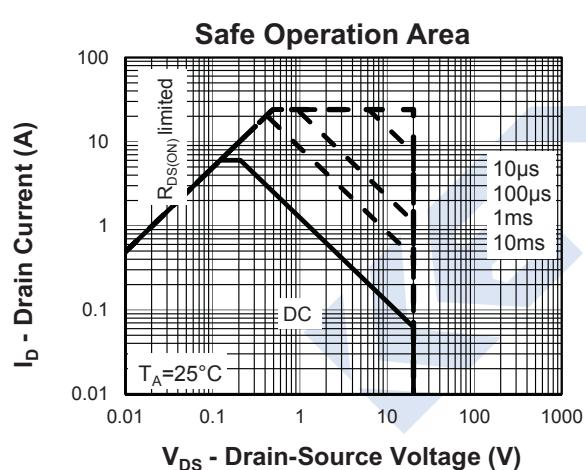
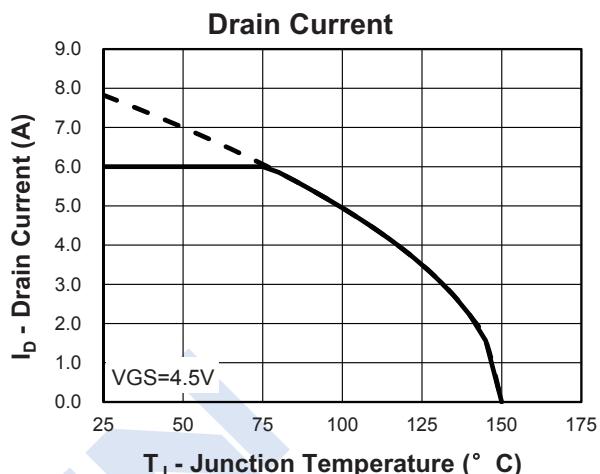
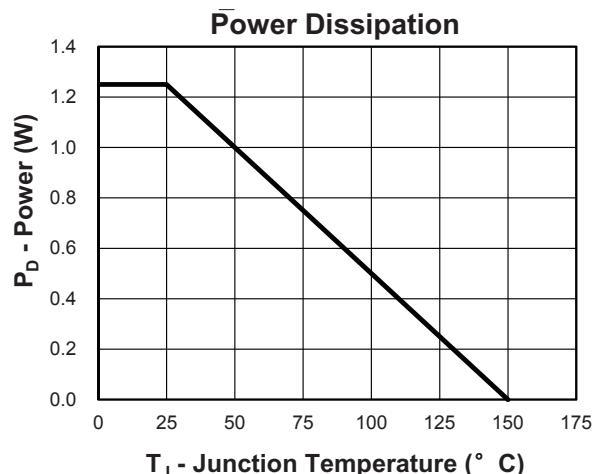
■ Marking

Marking	KBO
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N-Channel MOSFET

2KK5060

■ Typical Characteristics



N-Channel MOSFET

2KK5060

